

RM120N30DF

# **N-Channel Super Trench Power MOSFET**

## **Description**

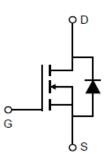
The RM120N30DF uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{\text{DS(ON)}}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

#### **General Features**

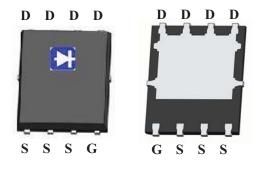
- $V_{DS} = 30V, I_D = 120A$   $R_{DS(ON)} = 1.95m\Omega$  (typical) @  $V_{GS} = 10V$  $R_{DS(ON)} = 2.85m\Omega$  (typical) @  $V_{GS} = 4.5V$
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

## **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



**Schematic Diagram** 



**Top View** 

**Bottom View** 

100% UIS TESTED!

100% ΔVds TESTED!

### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
120N30	RM120N30DF	DFN5X6-8L	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25°Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous (Silicon Limited)	I <sub>D</sub>	120	А
Drain Current-Continuous(T <sub>C</sub> =100°C)	I <sub>D</sub> (100℃)	84.8	Α
Pulsed Drain Current (Package Limited)	I <sub>DM</sub>	340	А
Maximum Power Dissipation	P <sub>D</sub>	75	W
Derating factor		0.6	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	600	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$ C

## **Thermal Characteristic**

Thermal Resistance, Junction-to-Case (Note 2)	$R_{ heta JC}$	1.67	°C/W	
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Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	30		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.2	1.7	2.2	V
Dunin Course On Chata Desintance	В	V <sub>GS</sub> =10V, I <sub>D</sub> =60A	-	1.95	2.35	mΩ
Drain-Source On-State Resistance Forward Transconductance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =60A	-	2.85	3.35	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =60A		60	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	1/ 45)/1/ 0)/	-	3550	4200	PF
Output Capacitance	Coss	$V_{DS}$ =15V, $V_{GS}$ =0V, F=1.0MHz	-	950	1100	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	r-1.0lvinz	-	63	78	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	9	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =15 $V$ , $I_D$ =60 $A$	-	4	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =1.6 $\Omega$	-	44	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	7	-	nS
Total Gate Charge	Qg	\/ -15\/  -60A	-	63	72	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =15V, $I_{D}$ =60A, $V_{GS}$ =10V	-	10		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> -10V	-	9.5		nC
Drain-Source Diode Characteristics					-	
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =60A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	170	Α
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25^{\circ}C, I_F = I_S$	-		26	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-		95	nC

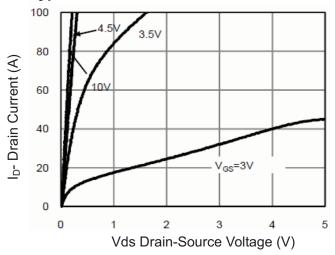
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board,  $t \leq 10 \ \text{sec.}$
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25  $^{\circ}$ C,V<sub>DD</sub>=15V,V<sub>G</sub>=10V,L=0.5mH,Rg=25 $\Omega$

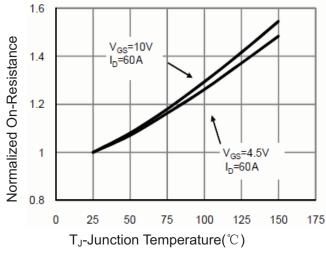


# RATING AND CHARACTERISTICS CURVES (RM120N30DF)

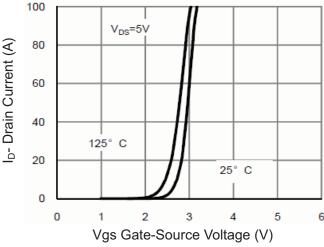
## **Typical Electrical and Thermal Characteristics**



**Figure 1 Output Characteristics** 



**Figure 4 Rdson-Junction Temperature** 



**Figure 2 Transfer Characteristics** 

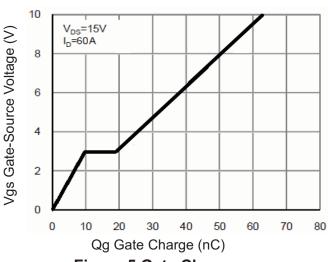


Figure 5 Gate Charge

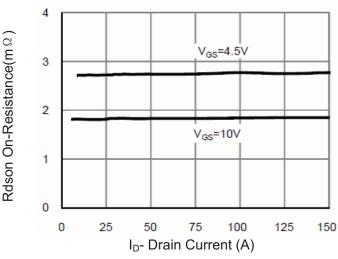


Figure 3 Rdson- Drain Current

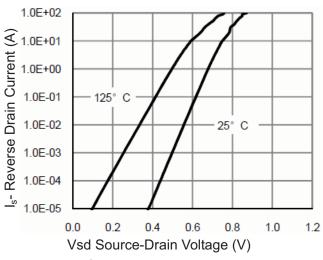


Figure 6 Source- Drain Diode Forward



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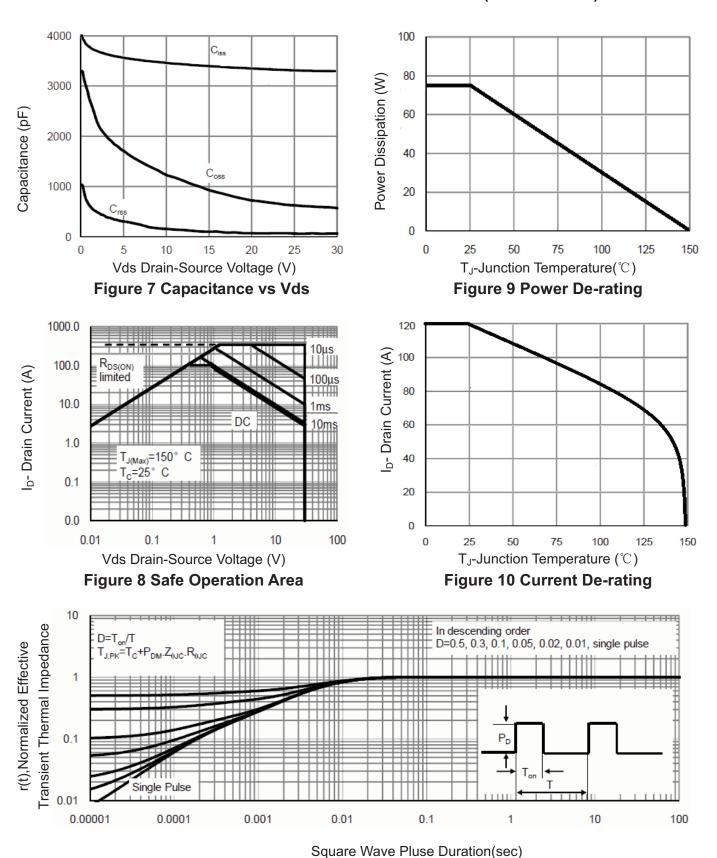
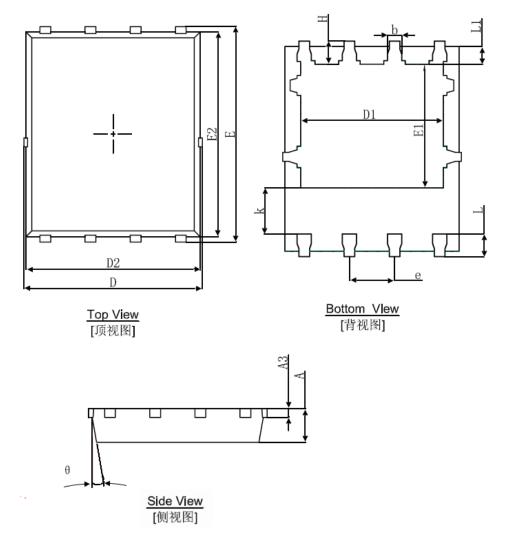


Figure 11 Normalized Maximum Transient Thermal Impedance



# **DFN5X6-8L Package Information**



Complete	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	0.900	1.000	0.035	0.039	
A3	0.254	REF.	0.010	REF.	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
е	1.270	1.270TYP. 0.050TY		TYP.	
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	



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